

DEHESIVE[®] PSA 630 T



Pressure Sensitive Adhesives

DEHESIVE[®] PSA 630 T is a solvent based Silicone Pressure Sensitive Adhesive intended in particular for coating on films, but also other substrates.

Properties

- excellent surface tack
- high adhesion levels
- high flexibility
- excellent thermal stability
- good resistance to moisture, weathering and ageing

Specific features

- Solvent-based

Technical data

General Characteristics

Property	Condition	Value	Method
Appearance	-	colorless	-
Content of active agent	-	62 %	-

These figures are only intended as a guide and should not be used in preparing specifications.

All the information provided is in accordance with the present state of our knowledge. Nonetheless, we disclaim any warranty or liability whatsoever and reserve the right, at any time, to effect technical alterations. The information provided, as well as the product's fitness for an intended application, should be checked by the buyer in preliminary trials. Contractual terms and conditions always take precedence. This disclaimer of warranty and liability also applies particularly in foreign countries with respect to third parties' rights.

Comprehensive instructions are given in the corresponding Material Safety Data Sheets. They are available on request from WACKER subsidiaries or may be downloaded via WACKER web site <http://www.wacker.com>.

Applications

- Si-PSA

Application details

DEHESIVE® PSA 630 T can be used for coating of several film-substrates such as Polyester, Polyamide, Polyimide and others substrates for manufacture of different silicone pressure sensitive adhesive tapes and other articles.

Processing

DEHESIVE® PSA 630 T can be diluted with aliphatic or aromatic solvent (e.g. toluene, white spirit, naphtha). It is typically blended with addition curing silicone PSA system (e.g. DEHESIVE® PSA 765). For an optimum balance of surface tack, adhesion strength and cohesive strength it is necessary to cure the coated DEHESIVE® PSA 630 T for 1 – 2 min. at 140 – 150°C by using adding DEHESIVE® 765 and catalyst C05 or PT 5. It is recommended to remove the solvent before curing process at 80 – 90 °C for ~0.5 min. Higher temperature can cause incorporation of the solvent into the adhesive film, which can impair the adhesive properties.

Packaging and storage

Storage

The 'Best use before end' date of each batch is shown on the product label.

Storage beyond the date specified on the label does not necessarily mean that the product is no longer usable. In this case however, the properties required for the intended use must be checked for quality assurance reasons.

QR Code DEHESIVE® PSA 630 T



For technical, quality or product safety questions, please contact:

Wacker Chemie AG, Hanns-Seidel-Platz 4, 81737 Munich, Germany
info@wacker.com, www.wacker.com

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